What details are required for surface types such as slurries and cape seals, and others?

Inventory collection examples of various mix types.

Field Description	RAMM Req.	Default	NZTA Req.	SMA Example	UTA Example	DGA Example
Road Name				As per Normal	As per Normal	As per Normal
Road ID	Y		T(M)	As per Normal	As per Normal	As per Normal
Start (m)	Y		T(M)	As per Normal	As per Normal	As per Normal
End (m)	Y		T(M)	As per Normal	As per Normal	As per Normal
Width (m)			T(M)	As per Normal	As per Normal	As per Normal
Full width (m)	Y		T(M)	As per Normal	As per Normal	As per Normal
Offset (LHS) (m)	Y	0	T(M)	As per Normal	As per Normal	As per Normal
Sealed Area (m2)			T(M)	As per Normal	As per Normal	As per Normal
Removed Date			T(C)			
Surfacing Date	Y		T(M)	As per Normal	As per Normal	As per Normal
Design Life (yrs)			T(M)	As per Normal	As per Normal	As per Normal
Function	Y		T(M)	R	R	R
Material	Y		T(M)	SMA	UTA	AC
Grade of 1st Chip	Y		T(M)	12	8	14
Grade of 2nd Chip			T(C)			
Depth	Y	0	T(M)	35	20	50
Calculated Depth	Y	Υ	T(M)	N	N	N
Reason			T(M)	CR	RA	SS
ALD 2dec.pl.			T(C)			
PSV			T(C)	58	62	56
Source			T(M)	As per Normal	As per Normal	As per Normal
Binder Type	Y		T(M)	B60	B80	B80
Cutter Quantity (pph)	Y	0	T(C)	0	0	0
Cutter Type			T(C)			
Adhesion Quantity (pph)	Y	0	T(C)	0	0	0
Adhesion Type			T(C)			
Flux (pph)	Y	0	T(C)	0	0	0
Additive Quantity (pph)	Υ	0	T(C)	1	1	0
Additive Type			T(C)	CF	CF	
Torsional Recovery (%)			T(C)	19	19	0
Softening Point (°C)			T(C)	52	52	0
Polymer Type			T(C)	AXM	AXM	
Polymer (%)			T(C)	2	2	0
Residual Rate (I/m²)			T(C)			
Contract Number			T(M)	As per Normal	As per Normal	As per Normal
Specification Type			T(M)	FHSMA	PAVETEK	P23P
Surfaced By			T(M)	As per Normal	As per Normal	As per Normal
Recycling	Y	F	T(M)	<i>.</i> F	F	F
Component %			T(C)	0	0	0
Component			T(C)	0	0	0
Comments			T(C)	SMA12 Mix with AXM PMB	PaveTex8 Mix with AXM PMB	DG Asphalt

Inventory collection examples of various mix types, slurry and cape seal.

Field Description	RAMM Req.	Default	NZTA Req.	OPGA HS SLAG Example	Membrane Seal Example	OGPA2 Example
Road Name				As per Normal	As per Normal	As per Normal
Road ID	Y		T(M)	As per Normal	As per Normal	As per Normal
Start (m)	Υ		T(M)	As per Normal	As per Normal	As per Normal
End (m)	Y		T(M)	As per Normal	As per Normal	As per Normal
Width (m)			T(M)	As per Normal	As per Normal	As per Normal
Full width (m)	Y		T(M)	As per Normal	As per Normal	As per Normal
Offset (LHS) (m)	Y	0	T(M)	As per Normal	As per Normal	As per Normal
Sealed Area (m2)			T(M)	As per Normal	As per Normal	As per Normal
Removed Date			T(C)			
Surfacing Date	Υ		T(M)	As per Normal	As per Normal	As per Normal
Design Life (yrs)			T(M)	As per Normal	As per Top Surface	As per Normal
Function	Y		T(M)	R	М	R
Material	Y		T(M)	OGPAH	1CHIP	OGPA2
Grade of 1st Chip	Y		T(M)	14	4	14
Grade of 2nd Chip			T(C)			20
Depth	Y	0	T(M)	35	0	85
Calculated Depth	Y	Υ	T(M)	N	Y	N
Reason			T(M)	RA	RA	SS
ALD 2dec.pl.			T(C)			
PSV			T(C)	60		60
Source			T(M)	As per Normal	As per Normal	As per Normal
Binder Type	Y		T(M)	B60	E180	B80
Cutter Quantity (pph)	Y	0	T(C)	0	2	0
Cutter Type			T(C)		Kero	
Adhesion Quantity (pph)	Υ	0	T(C)	0	0.5	0
Adhesion Type			T(C)		AG75	
Flux (pph)	Y	0	T(C)	0	0	0
Additive Quantity (pph)	Υ	0	T(C)	0	0	0
Additive Type			T(C)			
Torsional Recovery (%)			T(C)		75	50
Softening Point (°C)			T(C)		45	75
Polymer Type			T(C)		SXL	RSQR
Polymer (%)			T(C)		2	2
Residual Rate (I/m²)		-	T(C)		1.7	
Contract Number			T(M)	As per Normal	As per Normal	As per Normal
Specification Type			T(M)	P11HS	P1 7	P1 1
Surfaced By			T(M)	As per Normal	As per Normal	As per Normal
Recycling	Y	F	T(M)	Υ	F	F
Component %			T(C)	50	0	0
Component			T(C)	SLAG	0	0
Comments			T(C)	OGPA HS Mix with SLAG on Cat 1 site	PMB Membrane seal under OGPA	Twin layer OGPA for Noise suppression, PMB in top OGPA layer

Inventory collection examples of various mix types, slurry and cape seal.

Field Description	RAMM Req.	Default	NZTA Req.	Slurry Type 2 Example	Slurry Type 3 Example	Cape Seal Example
Road Name				As per Normal	As per Normal	As per Normal
Road ID	Υ		T(M)	As per Normal	As per Normal	As per Normal
Start (m)	Υ		T(M)	As per Normal	As per Normal	As per Normal
End (m)	Y		T(M)	As per Normal	As per Normal	As per Normal
Width (m)			T(M)	As per Normal	As per Normal	As per Normal
Full width (m)	Υ		T(M)	As per Normal	As per Normal	As per Normal
Offset (LHS) (m)	Y	0	T(M)	As per Normal	As per Normal	As per Normal
Sealed Area (m2)			T(M)	As per Normal	As per Normal	As per Normal
Removed Date			T(C)			
Surfacing Date	Y		T(M)	As per Normal	As per Normal	As per Normal
Design Life (yrs)			T(M)	As per Normal	As per Normal	As per Normal
Function	Υ		T(M)	R	R	R
Material	Υ		T(M)	SLRY	SLRY	CAPE
Grade of 1st Chip	Υ		T(M)	2	3	3
Grade of 2nd Chip			T(C)			2
Depth	Υ	0	T(M)	9	12	20
Calculated Depth	Υ	Υ	T(M)	N	N	N
Reason			T(M)	HS	RA	CR
ALD 2dec.pl.			T(C)			10.15
PSV			T(C)	57	57	57
Source			T(M)	As per Normal	As per Normal	As per Normal
Binder Type	Y		T(M)	E130	E130	E130
Cutter Quantity (pph)	Y	0	T(C)	0	0	2
Cutter Type			T(C)			Kero
Adhesion Quantity (pph)	Y	0	T(C)	0	0	0.5
Adhesion Type			T(C)			AG75
Flux (pph)	Y	0	T(C)	0	0	0
Additive Quantity (pph)	Y	0	T(C)	0	0	0
Additive Type			T(C)			
Torsional Recovery (%)			T(C)	19	19	75
Softening Point (°C)			T(C)	52	52	45
Polymer Type			T(C)	TMEH	TMEH	EFXC
Polymer (%)			T(C)	1	1	3
Residual Rate (I/m²)			T(C)			1.6
Contract Number			T(M)	As per Normal	As per Normal	As per Normal
Specification Type			T(M)	PSS	PSS	PSS
Surfaced By			T(M)	As per Normal	As per Normal	As per Normal
Recycling	Y	F	T(M)	Y	F	F
Component %			T(C)	50	0	0
Component			T(C)	SLAG	0	0
Comments			T(C)	Type 2 Slurry with PME per ISSA:A143	Type 3 Slurry with PME per ISSA:A143	G2 Chip Seal per M6, Type 3 PME Slurry per ISSA:A143